

RD74VT1G04

Single Inverter Buffer / Dual Supply Voltage Translator

REJ03D0514-0100 Rev.1.00 Mar. 29, 2005

Description

The RD74VT1G04 has an inverter in a 6-pin package. The input is designed to track $V_{\rm CC}IN$, which accepts voltage from 1.2 V to 3.6 V, and the output is designed to track $V_{\rm CC}OUT$, which operates at 1.2 V to 3.6 V. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- This product function as level shift that change $V_{CC}IN$ input level to $V_{CC}OUT$ output level by providing different supply voltage to $V_{CC}IN$ and $V_{CC}OUT$.
- Supplied on emboss taping for high-speed automatic mounting.
- The basic gate function is lined up as Renesas uni logic series.
- Supply voltage range: $V_{CC}IN = 1.2 \text{ V}$ to 3.6 V

$$V_{CC}OUT = 1.2 \text{ V to } 3.6 \text{ V}$$

Operating temperature range: -40 to +85°C

• All inputs: V_{IH} (Max.) = 3.6 V (@V_{CC}IN = 0 V to 3.6 V)

All outputs: $V_O(Max.) = 3.6 \text{ V} (@V_{CC}OUT = 0 \text{ V})$

• Output current: $\pm 2 \text{ mA} (@V_{CC}OUT = 1.2 \text{ V})$

 $\pm 4 \text{ mA } (@V_{CC}OUT = 1.4 \text{ V to } 1.6 \text{ V})$

 $\pm 6 \text{ mA} (@V_{CC}OUT = 1.65 \text{ V to } 1.95 \text{ V})$

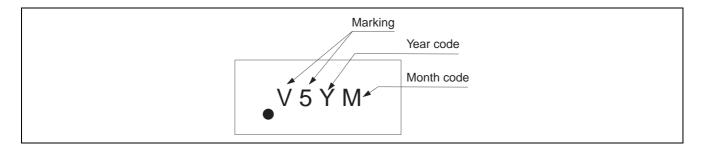
 $\pm 18 \text{ mA}$ (@V_{CC}OUT = 2.3 V to 2.7 V)

 $\pm 24 \text{ mA} (@V_{CC}OUT = 3.0 \text{ V to } 3.6 \text{ V})$

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
RD74VT1G04CLE	WCSP-6 pin	SXBG0006KB-A (TBS-6AV)	CL	E (3,000 pcs/reel)

Article Indication

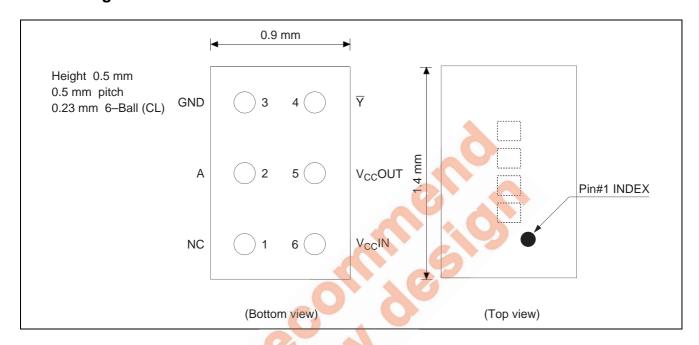


Function Table

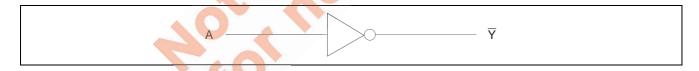
Input A	Output $\overline{\overline{Y}}$
Н	L
L	Н

H: High level L: Low level

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{CC} IN, V _{CC} OUT	-0.5 to 4.6	V	
Input voltage range *1	Vı	-0.5 to 4.6	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} OUT+0.5	V	Output: "H" or "L"
		-0.5 to 4.6		V _{CC} OUT: OFF
Input clamp current	l _{IK}	– 50	mA	V ₁ < 0
Output clamp current	I _{OK}	– 50	mA	V _O < 0
		50		$V_{\rm O} > V_{\rm CC} + 0.5$
Continuous output current	I ₀	±50	mA	
Continuous output current V _{CC} or GND	I _{CC} IN, I _{CC} OUT, I _{GND}	±100	mA	
Package Thermal impedance	θ_{ja}	123	°C/W	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 4.6 V maximum.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{CC} IN	1.2 to 3.6	V	
	V _{CC} OUT	1.2 to 3.6		
Input/Output voltage	VI	0 to 3.6	V	
	Vo	0 to V _{CC} OUT	V	Output: "H" or "L"
		0 to 3.6		V _{CC} OUT: OFF
Output current	Іон (-2	mA	V _{CC} OUT = 1.2 V
		-4		V _{CC} OUT = 1.5±0.1 V
		-6		V _{CC} OUT = 1.8±0.15 V
		-18		V _{CC} OUT = 2.5±0.2 V
		-24		$V_{CC}OUT = 3.3 \pm 0.3 \text{ V}$
	l _{OL}	2	mA	V _{CC} OUT = 1.2 V
		4		V _{CC} OUT = 1.5±0.1 V
		6		V _{CC} OUT = 1.8±0.15 V
		18		V _{CC} OUT = 2.5±0.2 V
		24		$V_{CC}OUT = 3.3 \pm 0.3 V$
Input transition rise or fall time	Δt / Δv	10	ns / V	
Operation free-air temperature	Та	-40 to 85	°C	

Electrical Characteristics

 $(Ta = -40 \text{ to } 85^{\circ}C)$

Item	Symbol	V _{CC} IN (V) [*]	V _{CC} OUT (V)*	Min	Тур	Max	Unit	Test conditions
Input voltage	V _{IH}	1.2	1.2 to 3.6	V _{CC} IN×0.75		_	٧	
		1.5±0.1		V _{CC} IN×0.70		_		
		1.8±0.15		V _{CC} IN×0.65		_		
		2.5±0.2		1.6	_	_		
		3.3±0.3		2.0		_		
	V_{IL}	1.2	1.2 to 3.6	_		V _{CC} IN×0.25	V	
		1.5±0.1		_	_	V _{CC} IN×0.30		
		1.8±0.15		_		V _{CC} IN×0.35		
		2.5±0.2			_	0.7		
		3.3±0.3		_		0.8		
Output voltage	V _{OH}	1.2 to 3.6	1.2 to 3.6	V _{CC} OUT-0.2		_	V	$I_{OH} = -100 \mu A$
			1.2	0.9		_		$I_{OH} = -2 \text{ mA}$
			1.5±0.1	1.1				$I_{OH} = -4 \text{ mA}$
			1.8±0.15	1.25				$I_{OH} = -6 \text{ mA}$
			2.5±0.2	1.7	<			$I_{OH} = -18 \text{ mA}$
			3.3±0.3	2.2		—		$I_{OH} = -24 \text{ mA}$
	V_{OL}	1.2 to 3.6	1.2 to 3.6			0.2	V	$I_{OL} = 100 \mu A$
			1.2	- 4	_	0.3		I _{OL} = 2 mA
			1.5±0.1		_	0.3		I _{OL} = 4 mA
			1.8±0.15	A		0.3		I _{OL} = 6 mA
			2.5±0.2	-		0.6		I _{OL} = 18 mA
			3.3±0.3	U - (0.55		I _{OL} = 24 mA
Input current	I _{IN}	3.6	3.6	-1.0		1.0	μΑ	$V_{IN} = GND \text{ or } V_{CC}IN$
Output leakage current	I _{OFF}	0	0			1.5	μΑ	V _{IN} , V _{OUT} = 0 to 3.6 V
Quiescent supply current	IccIN	1.2 to 3.6	1.2 to 3.6	-3.0		3.0	μΑ	$I_{O(\overline{Y} \text{ port})} = 0$ $V_{IN} = V_{CC}IN \text{ or GND}$
	I _{CC} OUT	1.2 to 3.6	1.2 to 3.6	-3.0	_	3.0		$I_{O(\overline{Y} \text{ port})} = 0$ $V_{IN} = V_{CC}IN \text{ or GND}$
Increase in I _{CC} per input	ΔI_{CC}	3.6	3.6	_	_	250	μΑ	A port V _{CC} IN-0.6 (1 input)
Input capacitance	Cin	3.3	3.3	_	3.5	_	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC}IN = 3.3 \pm 0.3 \ V$

						Ta = −40 to 85°C								
				V _{cc} OUT=	VccC	UT=	VccC	UT=	VccC	=TU	VccC	UT=		
		FROM	то	1.2V	1.5±	0.1V	1.8±0).15V	2.5±	0.2V	3.3±	0.3V		Test
Item	Symbol	(Input)	(Output)	Тур	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Conditions
Propagation	t _{PLH}	Α	Y	8.6	2.0	8.9	1.5	5.5	1.0	4.1	1.0	3.6	ns	C _L = 15 pF
delay time	t _{PHL}			8.6	2.0	8.9	1.5	5.5	1.0	4.1	1.0	3.6		$R_L = 2.0 \text{ k}\Omega$



Switching Characteristics (Cont.)

 $V_{CC}IN=2.5\pm0.2\ V$

						Та	= -40) to 85	°C					
				V _{cc} OUT=	VccC	UT=	VccC	DUT=	VccC	UT=	VccC	UT=		
		FROM	то	1.2V	1.5±	0.1V	1.8±0).15V	2.5±	0.2V	3.3±	0.3V		Test
Item	Symbol	(Input)	(Output)	Тур	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Conditions
Propagation	t _{PLH}	Α	Y	9.2	2.0	8.8	1.5	5.7	1.0	4.3	1.0	3.9	ns	C _L = 15 pF
delay time	t _{PHL}			9.2	2.0	8.8	1.5	5.7	1.0	4.3	1.0	3.9		$R_L = 2.0 \text{ k}\Omega$

 $V_{CC}IN=1.8\pm0.15\ V$

						Ta	= -40	to 85	°C					
				V _{cc} OUT=	VccC	UT=	VccC	UT=	VccC	=TU	VccC	UT=		
		FROM	то	1.2V	1.5±	0.1V	1.8±0).15V	2.5±	0.2V	3.3±	0.3V		Test
Item	Symbol	(Input)	(Output)	Тур	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Conditions
Propagation	t _{PLH}	Α	Y	9.5	2.0	9.2	1.5	6.0	1.0	4.7	1.0	4.3	ns	C _L = 15 pF
delay time	t _{PHL}			9.5	2.0	9.2	1.5	6.0	1.0	4.7	1.0	4.3		$R_L = 2.0 \text{ k}\Omega$

 $V_{CC}IN = 1.5 \pm 0.1 \text{ V}$

						Та	= -40	to 85	°C					
				V _{cc} OUT=	VccC	UT=	V _{cc} C	UT=	VccC	UT=	VccC	UT=		
		FROM	то	1.2V	1.5±	0.1V	1.8±0).15V	2.5±	0.2V	3.3±	0.3V		Test
Item	Symbol	(Input)	(Output)	Тур	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Conditions
Propagation	t _{PLH}	Α	Ÿ	9.5	2.0	9.7	1.5	6.8	1.0	5.2	1.0	5.0	ns	C _L = 15 pF
delay time	t _{PHL}			9.5	2.0	9.7	1.5	6.8	1.0	5.2	1.0	5.0		$R_L = 2.0 \text{ k}\Omega$

 $V_{CC}IN = 1.2 V$

					Ta = -40 to 85°C							
				V _{cc} OUT=								
		FROM	TO	1.2V	1.5±0.1V	1.8±0.15V	2.5±0.2V	3.3±0.3V		Test		
Item	Symbol	(Input)	(Output)	Тур	Тур	Тур	Тур	Тур	Unit	Conditions		
Propagation	t _{PLH}	A	Y	10.5	7.5	5.9	4.4	4.2	ns	C _L = 15 pF		
delay time	t _{PHL}	1		10.5	7.5	5.9	4.4	4.2		$R_L = 2.0 \text{ k}\Omega$		

Operating Characteristics

				Ta = 25°C				
Item	Symbol	V _{CC} IN (V)	V _{CC} OUT (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C_{PD}	3.3	3.3		12	ı	pF	f = 10 MHz $C_L = 0$

Power-up Considerations

Level-translation devices offer an opportunity for successful mixed-voltage signal design.

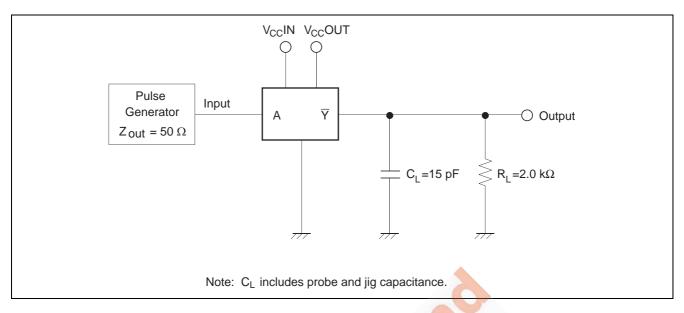
A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins.

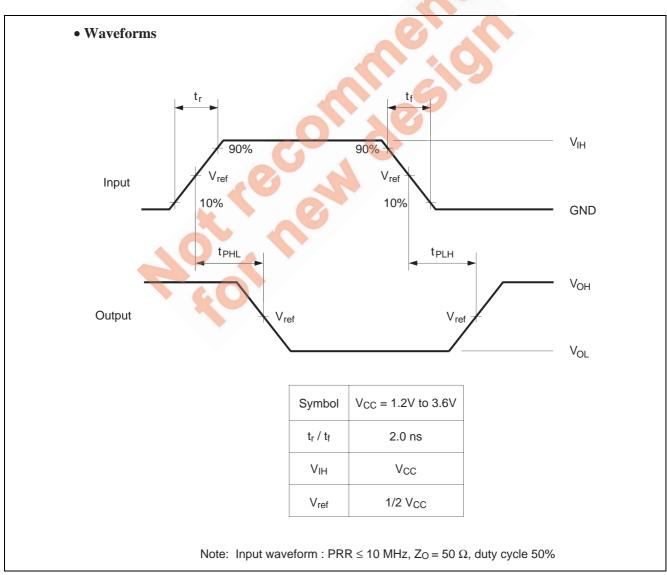
Take these precautions to guard against such power-up problems.

- 1. Connect ground before any supply voltage is applied.
- 2. Next, Power up the input side of the device. (Power up of $V_{CC}IN$ is first, Next power up is $V_{CC}OUT$)

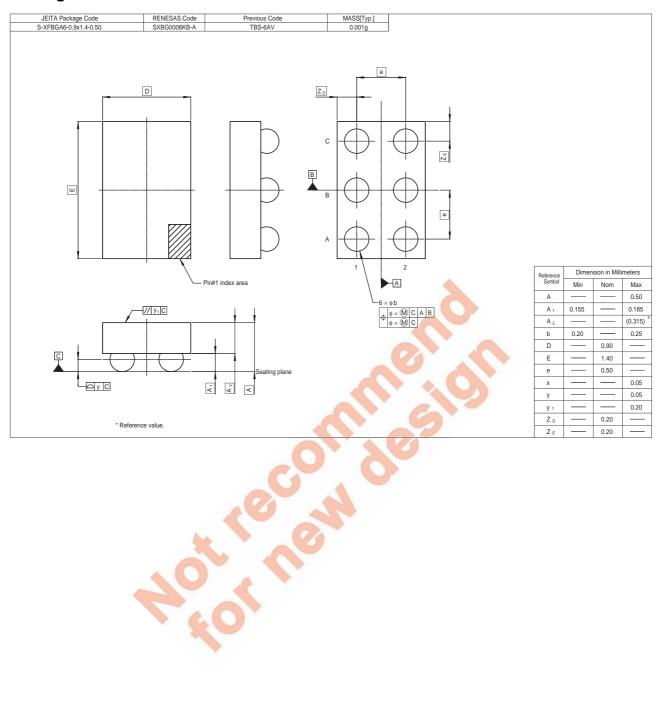


Test Circuit





Package Dimensions



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